

TOSHIBA Field Effect Transistor with Built-in Schottky Barrier Diode
Silicon N-Channel MOS Type (U-MOS V-H)

TPCC8A01-H

High Efficiency DC-DC Converter Applications

Notebook PC Applications

Portable Equipment Applications

- Built-in a Schottky barrier diode
Low forward voltage: $V_{DSF} = -0.6$ V (max)
- High-speed switching
- Small gate charge: $Q_{SW} = 4.1$ nC (typ.)
- Low drain-source ON-resistance:
 $R_{DS(ON)} = 9.0$ m Ω (typ.) ($V_{GS} = 4.5$ V)
- High forward transfer admittance: $|Y_{fs}| = 52$ S (typ.)
- Low leakage current: $I_{DSS} = 100$ μ A (max) ($V_{DS} = 30$ V)
- Enhancement mode: $V_{th} = 1.3$ to 2.3 V ($V_{DS} = 10$ V, $I_D = 1$ mA)

Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

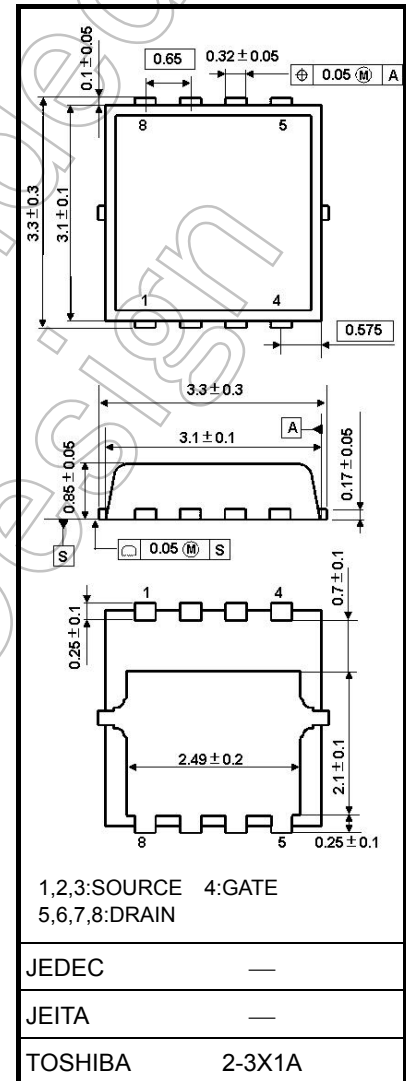
Characteristic	Symbol	Rating	Unit
Drain-source voltage	V_{DSS}	30	V
Drain-gate voltage ($R_{GS} = 20$ k Ω)	V_{DGR}	30	V
Gate-source voltage	V_{GSS}	± 20	V
Drain current	DC (Note 1)	I_D	A
	Pulsed (Note 1)	I_{DP}	
Drain power dissipation ($T_c = 25^\circ\text{C}$)	P_D	30	W
Drain power dissipation ($t = 10$ s) (Note 2a)	P_D	1.9	W
Drain power dissipation ($t = 10$ s) (Note 2b)	P_D	0.7	W
Single-pulse avalanche energy (Note 3)	E_{AS}	115	mJ
Avalanche current	I_{AR}	21	A
Repetitive avalanche energy ($T_c = 25^\circ\text{C}$) (Note 4)	E_{AR}	1.84	mJ
Channel temperature	T_{ch}	150	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55 to 150	$^\circ\text{C}$

Note: For Notes 1 to 4, refer to the next page.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

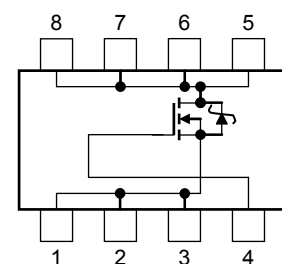
This transistor is an electrostatic-sensitive device. Handle with care.

Unit: mm



Weight: 0.02 g (typ.)

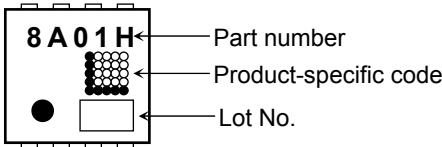
Circuit Configuration



Thermal Characteristics

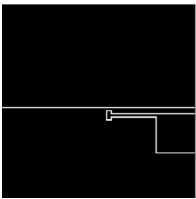
Characteristic	Symbol	Max	Unit
Thermal resistance, channel to case ($T_c = 25^{\circ}\text{C}$)	$R_{th (ch-c)}$	4.2	$^{\circ}\text{C/W}$
Thermal resistance, channel to ambient ($t = 10\text{ s}$) (Note 2a)	$R_{th (ch-a)}$	66	$^{\circ}\text{C/W}$
Thermal resistance, channel to ambient ($t = 10\text{ s}$) (Note 2b)	$R_{th (ch-a)}$	180	$^{\circ}\text{C/W}$

Marking (Note 5)



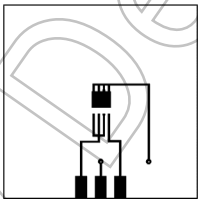
Note 1: Ensure that the channel temperature does not exceed 150°C .

Note 2: (a) Device mounted on a glass-epoxy board (a) (b) Device mounted on a glass-epoxy board (b)



(a)

FR-4
 $25.4 \times 25.4 \times 0.8$
(Unit: mm)



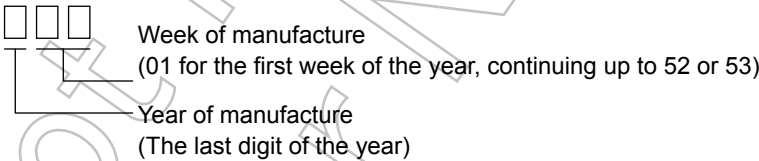
(b)

FR-4
 $25.4 \times 25.4 \times 0.8$
(Unit: mm)

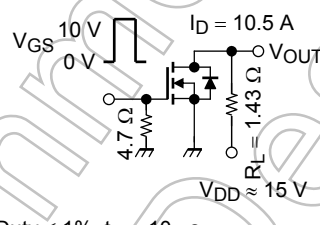
Note 3: $V_{DD} = 24\text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), $L = 200\text{ }\mu\text{H}$, $R_G = 25\text{ }\Omega$, $I_{AR} = 21\text{ A}$

Note 4: Repetitive rating: pulse width limited by maximum channel temperature

Note 5: * Weekly code: (Three digits)

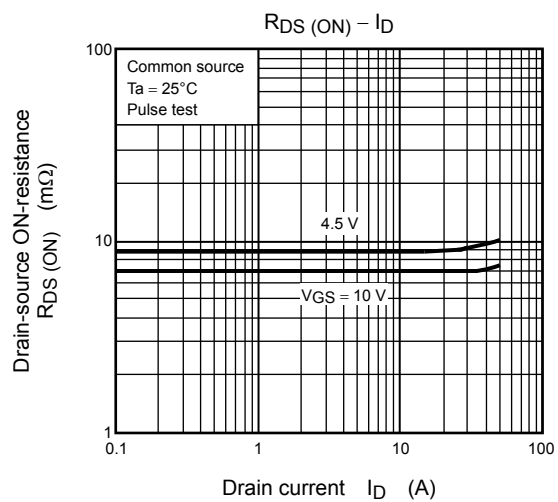
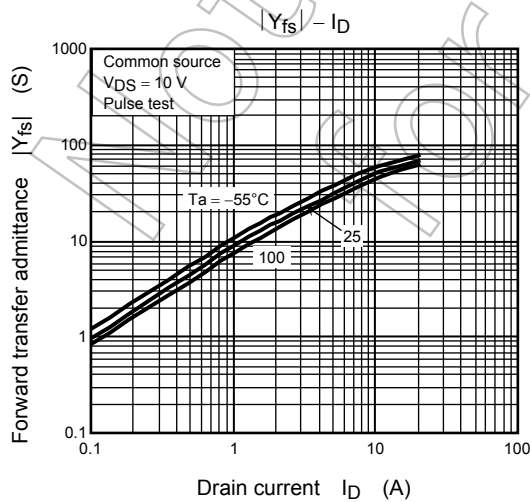
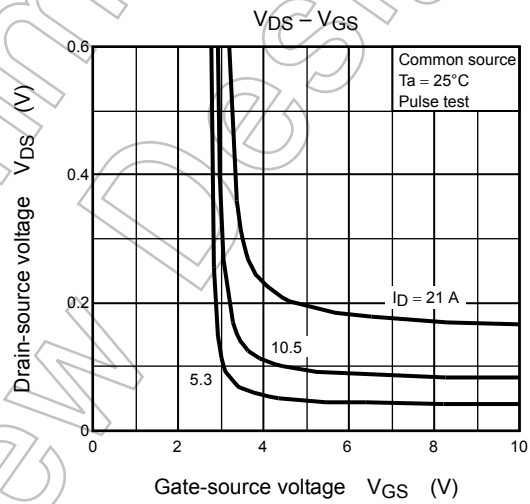
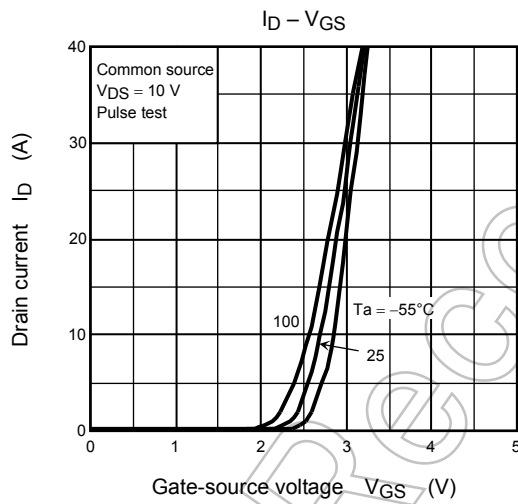
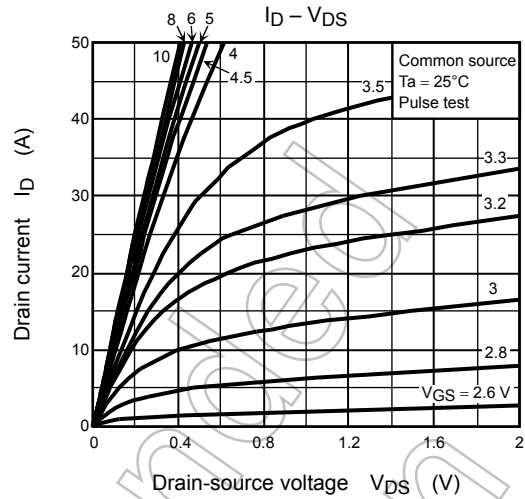
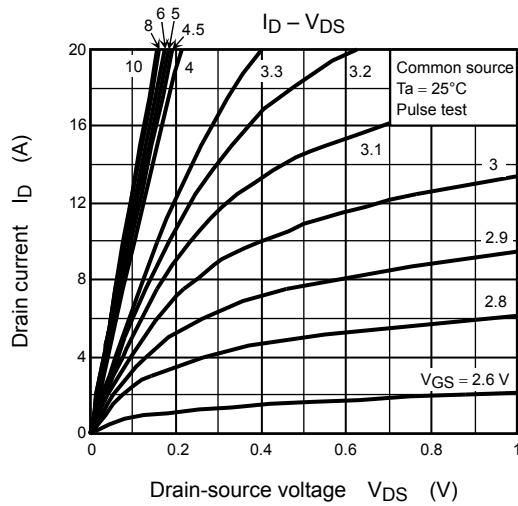


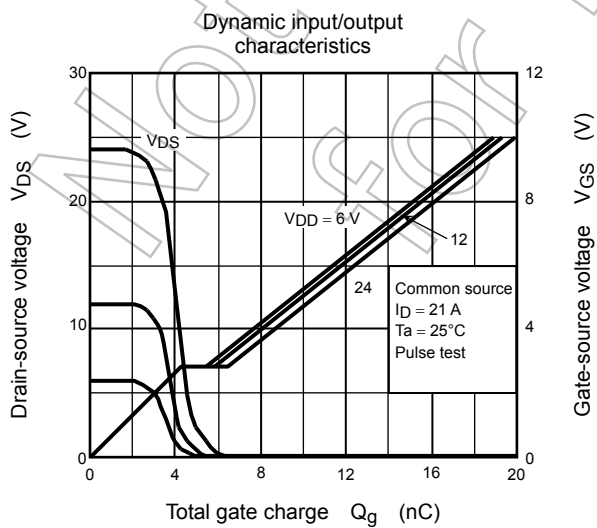
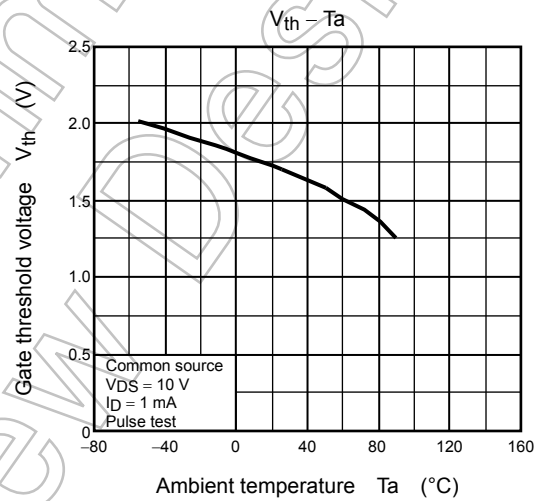
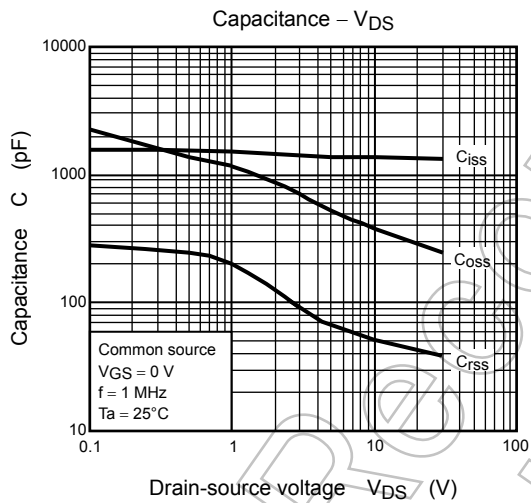
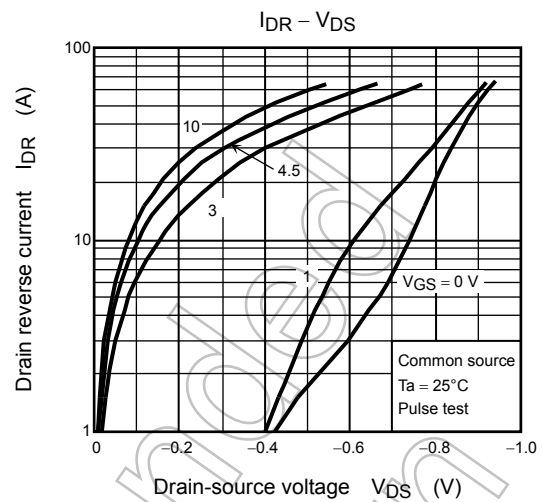
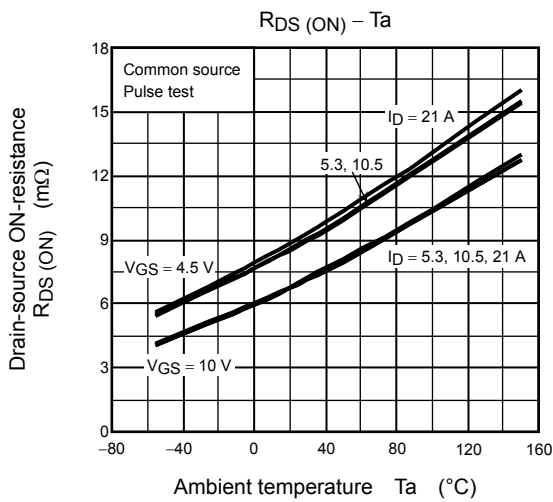
Electrical Characteristics (Ta = 25°C)

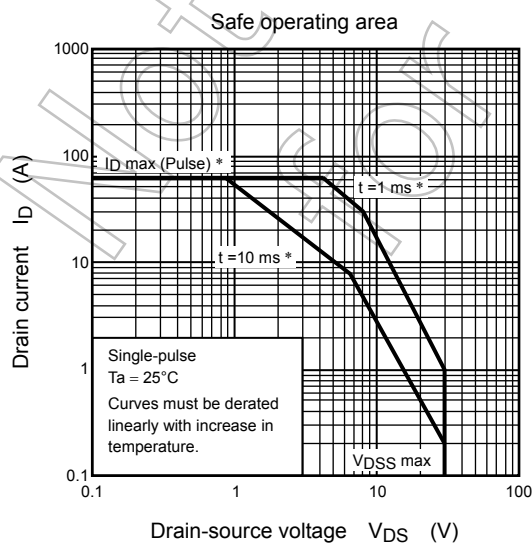
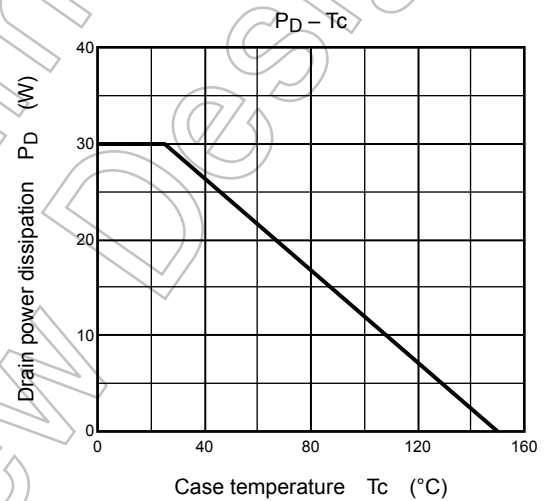
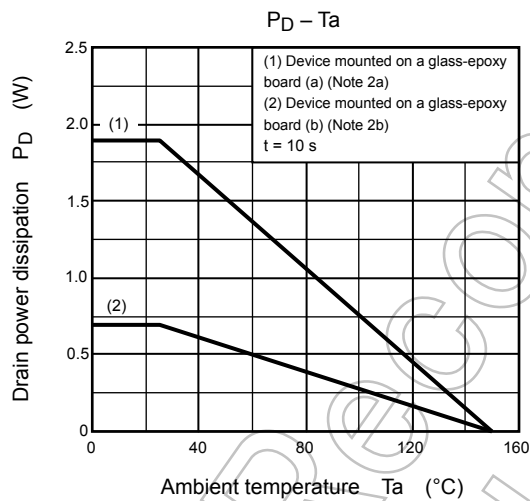
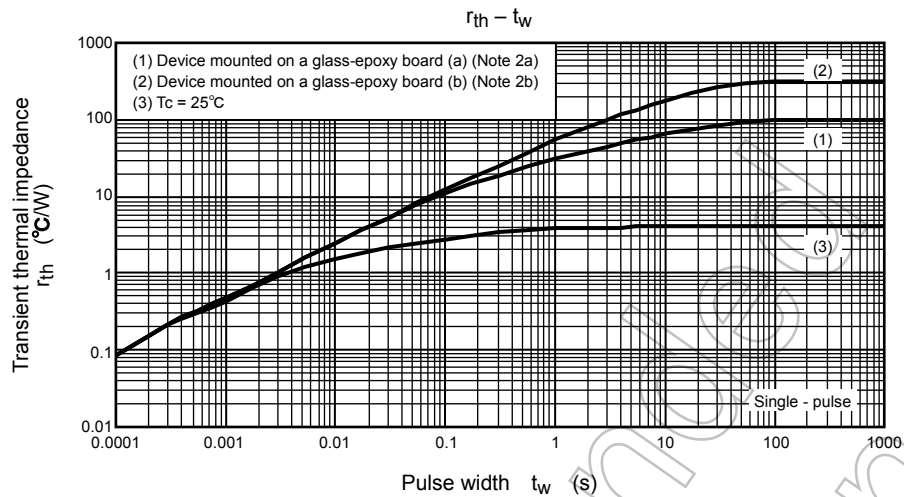
Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I _{GSS}	V _{GS} = ±20 V, V _{DS} = 0 V	—	—	±100	nA
Drain cut-off current		I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	—	—	100	μA
Drain-source breakdown voltage		V _(BR) DSS	I _D = 10 mA, V _{GS} = 0 V	30	—	—	V
		V _(BR) DSX	I _D = 10 mA, V _{GS} = −20 V	15	—	—	
Gate threshold voltage		V _{th}	V _{DS} = 10 V, I _D = 1 mA	1.3	—	2.3	V
Drain-source ON-resistance		R _{DS} (ON)	V _{GS} = 4.5 V, I _D = 10.5 A	—	9.0	12.6	mΩ
			V _{GS} = 10 V, I _D = 10.5 A	—	7.1	9.9	
Forward transfer admittance		Y _{fs}	V _{DS} = 10 V, I _D = 10.5 A	26	52	—	S
Input capacitance		C _{iss}	V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz	—	1430	1900	pF
Reverse transfer capacitance		C _{rss}		—	54	81	
Output capacitance		C _{oss}		—	380	—	
Gate resistance		r _g	V _{DS} = 10 V, V _{GS} = 0 V, f = 5 MHz	—	1.5	2.3	Ω
Switching time	Rise time	t _r		—	2.2	—	ns
	Turn-on time	t _{on}		—	7.7	—	
	Fall time	t _f		—	3.4	—	
	Turn-off time	t _{off}		Duty ≤ 1%, t _w = 10 μs	—	22	
Total gate charge (gate-source plus gate-drain)		Q _g	V _{DD} ≈ 24 V, V _{GS} = 10 V, I _D = 21 A	—	20	—	nC
			V _{DD} ≈ 24 V, V _{GS} = 5 V, I _D = 21 A	—	10.1	—	
Gate-source charge 1		Q _{gs1}	V _{DD} ≈ 24 V, V _{GS} = 10 V, I _D = 21 A	—	4.3	—	
Gate-drain (“Miller”) charge		Q _{gd}		—	2.1	—	
Gate switch charge		Q _{sw}		—	4.1	—	

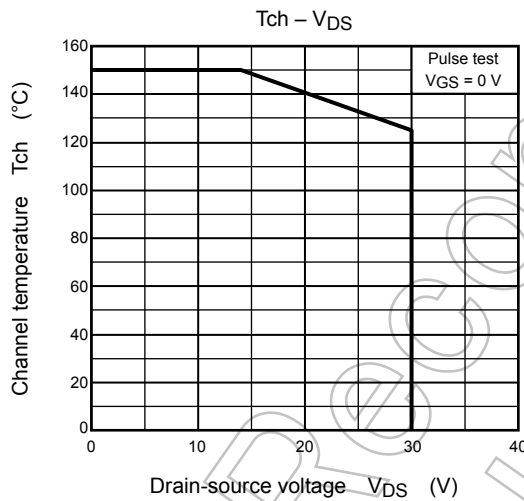
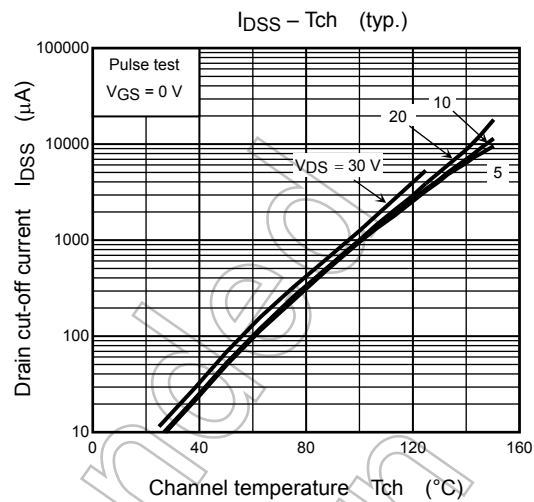
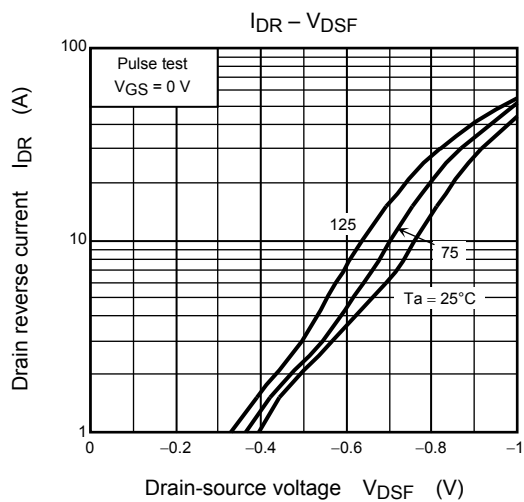
Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Drain reverse current	Pulse (Note 1)	I_{DRP}	—	—	—	63	A
Forward voltage (diode)		V_{DSF}	$I_{DR} = 1 \text{ A}, V_{GS} = 0 \text{ V}$	—	-0.4	-0.6	V
			$I_{DR} = 21 \text{ A}, V_{GS} = 0 \text{ V}$	—	—	-1.2	V









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